

Title (en)

High-strength cold-rolled steel sheet excellent in coating film adhesion

Title (de)

Hochfestes, Kaltgewalztes Stahlblech mit Ausgezeichneter Adhesion von Beschichtung

Title (fr)

Tôle d'acier à résistance élevée laminée à froid, ayant une excellente adhésivité d'une couche de revêtement

Publication

EP 1548142 A1 20050629 (EN)

Application

EP 04028368 A 20041130

Priority

JP 2003429151 A 20031225

Abstract (en)

A cold-rolled steel sheet of DP (Dual Phase) type with a specific composition meets the requirements: (I) In the surface of the steel sheet, there exist Si-Mn complex oxides no larger than 5 μm in diameter of the equivalent circle as many as 10 or more per 100 μm^2 and the coverage of oxides composed mainly of Si on the surface of steel sheet is no more than 10% of surface area, and/or (II) The cross section near the surface of the steel sheet does not show cracks with a width no larger than 3 μm and a depth no smaller than 5 μm in arbitrary ten fields of observation under an SEM with a magnification of 2000. A high-strength cold-rolled steel sheet excellent in coating film adhesion and having a tensile strength no lower than 550 MPa is provided.

IPC 1-7

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IPC 8 full level

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CPC (source: EP US)

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Citation (search report)

- [A] PATENT ABSTRACTS OF JAPAN vol. 2002, no. 04 4 August 2002 (2002-08-04)
- [DA] PATENT ABSTRACTS OF JAPAN vol. 017, no. 073 (C - 1026) 15 February 1993 (1993-02-15)
- [A] PATENT ABSTRACTS OF JAPAN vol. 2003, no. 09 3 September 2003 (2003-09-03)
- [A] PATENT ABSTRACTS OF JAPAN vol. 1998, no. 11 30 September 1998 (1998-09-30)
- [A] PATENT ABSTRACTS OF JAPAN vol. 1998, no. 04 31 March 1998 (1998-03-31)
- [DPA] DATABASE WPI Section Ch Week 200477, Derwent World Patents Index; Class M24, AN 2004-780743, XP002314973

Cited by

EP2028282A1; EP2785889A4; CN102317490A; EP2623630A4; EP3421634A1; EP2123786A1; RU2470087C2; EP1865085A4; EP2671960A1; EP2671961A1; EP2679699A3; GB2433746A; GB2433746B; EP3418419A4; US9598743B2; US10449751B2; US8986468B2; WO2009021897A1; WO2008102009A1; US10190187B2; US9534270B2; US11453926B2; US8801873B2; US10612113B2; WO2009150319A1; WO2015014333A3; US9085816B2; EP2829626B1

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